Switch-mode **Power Rectifier**

MUR550APFG, MURD550PFG, **MUR550PFG**, MURF550PFG, NRVUD550PFT4G, NRVUD550PFT4G-VF01

These state-of-the-art devices are designed for power factor correction in discontinuous and critical conduction mode.

Features

- 520 V Rating Meets 80% Derating Requirements of Major OEMs
- Low Forward Voltage Drop
- Low Leakage
- Ultrafast 95 Nanosecond Recovery Time
- Reduces Forward Conduction Loss
- NRVUD Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- DCM PFC Designs
- Switching Power Supplies
- Power Inverters

Mechanical Characteristics:

- Case: Epoxy, Molded
- Epoxy Meets UL 94 V-0 @ 0.125 in
- MUR550APFG: 1.1 Gram (Approximately) • Weight:

MURD550PFG, NRVUD550PFT4G, NRVUD550PFT4G-VF01: 0.4 Gram

(Approximately)

MUR550PFG, MURF550PFG: 1.9 Gram

(Approximately)

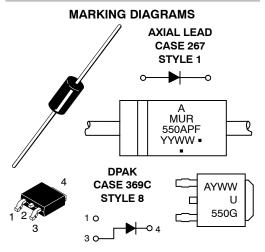
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds



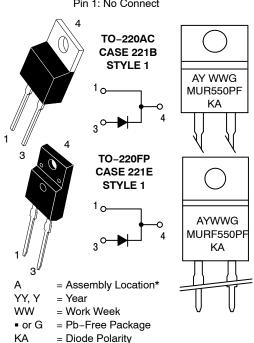
ON Semiconductor®

www.onsemi.com

ULTRAFAST RECTIFIER 5.0 AMPERES, 520 VOLTS



Pin 1: No Connect



*The Assembly Location Code (A) is front side optional. In cases where the Assembly Location is stamped in the package bottom (molding ejecter pin), the front side assembly code may be blank.

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
MUR550APFG	Axial	500 Units/Bag
MUR550APFRLG	Axial	1,500 Tape & Reel
MURD550PFT4G	DPAK (Pb-Free)	2,500 Tape & Reel
NRVUD550PFT4G*	DPAK (Pb-Free)	2,500 Tape & Reel
NRVUD550PFT4G-VF01*	DPAK (Pb-Free)	50 Units / Rail
MUR550PFG	TO-220AC (Pb-Free)	50 Units / Rail
MURF550PFG	TO-220FP (Pb-Free)	50 Units / Rail

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	520	V
	I _{F(AV)}	5.0 5.0	Α
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, 60 Hz) MUR550APFG NRVUD550PFT4G, NRVUD550PFT4G-VF01, MURD550PFG MUR550PFG, MURF550PFG	I _{FSM}	85 75 100	А
Operating Junction Temperature Range	TJ	-65 to +175	°C
Storage Temperature Range	T _{stg}	-65 to +175	°C
ESD Ratings: Machine Model = C Human Body Model = 3B	ESD	> 400 > 8000	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Note 1) MURD550PG, MUR550PFG, NRVUD550PFT4G, NRVUD550PFT4G-VF01 MURF550PFG	$R_{ heta JC}$	2.8 5.75	°C/W
Thermal Resistance, Junction-to-Ambient MUR550APFG NRVUD550PFT4G, NRVUD550PFT4G-VF01, MURD550PFG (Note 3), MURF550PFG	$R_{ hetaJA}$	Note 2 62 75	°C/W

- 1. Rating applies when surface mounted on the minimum pad sizes recommended.
- 2. See Note 2, Ambient Mounting Data.
- 3. 1 inch square pad size on FR4 board.

^{*}NRVUD Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage Drop (Note 4) ($I_F = 5.0 \text{ A}, T_J = 25^{\circ}\text{C}$) ($I_F = 5.0 \text{ A}, T_J = 150^{\circ}\text{C}$)	V _F	1.15 0.98	V
Maximum Instantaneous Reverse Current (Note 4) $ (V_R = 520 \text{ V}, T_J = 25^{\circ}\text{C}) $ $ (V_R = 520 \text{ V}, T_J = 150^{\circ}\text{C}) $	I _R	5.0 400	μΑ
Maximum Reverse Recovery Time (I _F = 1.0 A, di/dt = 50 A/ μ s, V _R = 30 V, T _J = 25°C)	t _{rr}	95	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse Test: Pulse Width = 300 µs, Duty Cycle ≤ 2.0%.

NOTE 2 — AMBIENT MOUNTING DATA

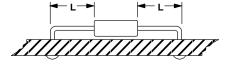
Data shown for thermal resistance junction—to—ambient $(R_{\theta JA})$ for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

TYPICAL VALUES FOR $\textbf{R}_{\theta \text{JA}}$ IN STILL AIR

Mounting		Lea	ıd Leng	th, L (II	N)	
Metho	d	1/8	1/4	1/2	3/4	Units
1		50	51	53	55	°C/W
2	$R_{\theta JA}$	58	59	61	63	°C/W
3			28			°C/W

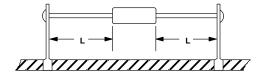
MOUNTING METHOD 1

P.C. Board Where Available Copper Surface area is small.



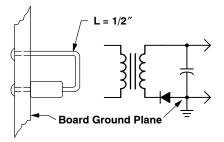
MOUNTING METHOD 2

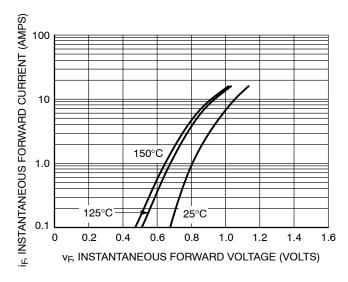
Vector Push-In Terminals T-28



MOUNTING METHOD 3

P.C. Board with 1-1/2'' x 1-1/2'' Copper Surface





NAMANDO 10 150°C 25°C 0.1 0 0.2 0.4 0.6 0.8 1.0 1.2 1.4 1.6 (VOLTS)

Figure 1. Typical Forward Voltage

Figure 2. Maximum Forward Voltage

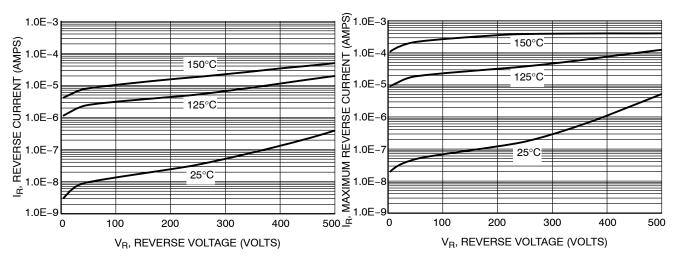


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current

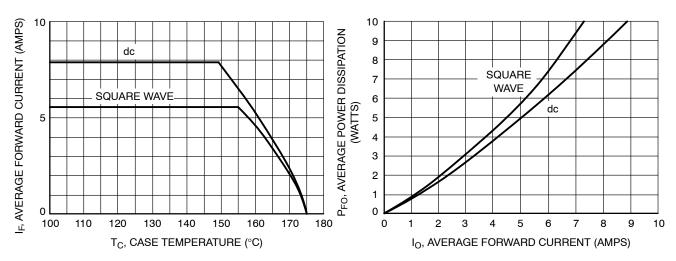


Figure 5. Current Derating

Figure 6. Forward Power Dissipation

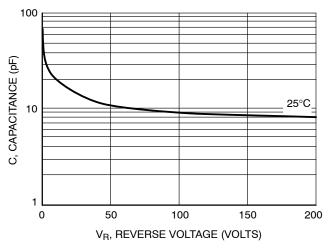


Figure 7. Capacitance

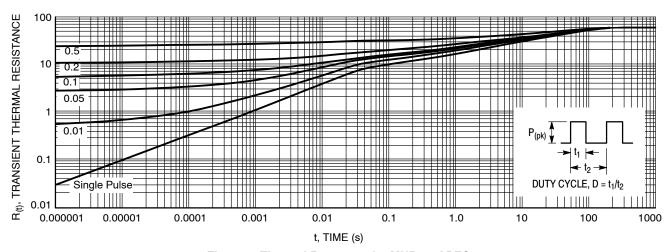


Figure 8. Thermal Response for MUR550APFG

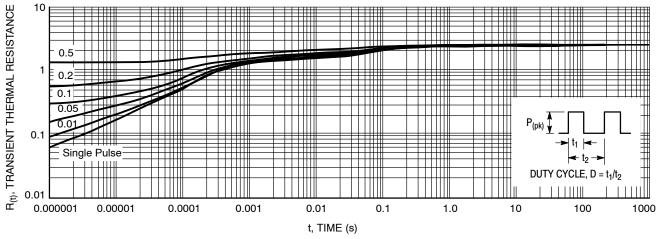


Figure 9. Thermal Response for MURD550PFG, NRVUD550PFT4G, NRVUD550PFT4G-VF01

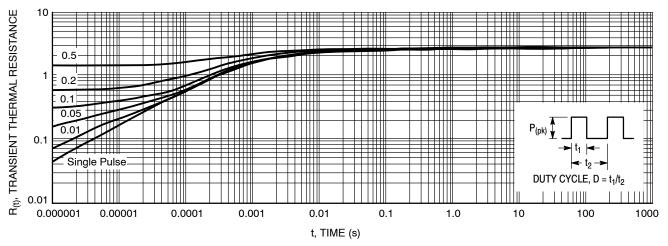


Figure 10. Thermal Response for MUR550PFG

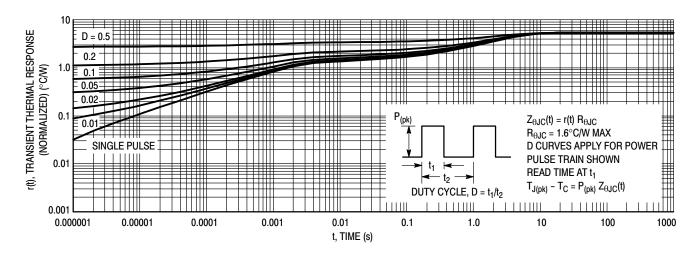


Figure 11. Thermal Response, (MURF550PFG) Junction-to-Case ($R_{\theta JC}$)

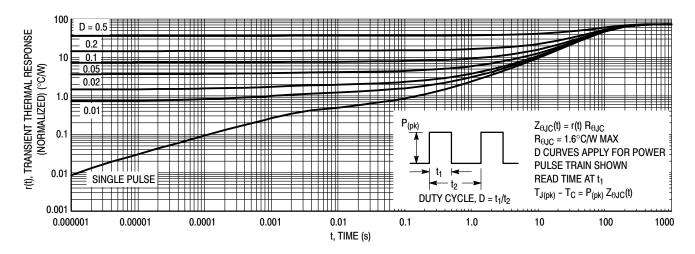


Figure 12. Thermal Response, (MURF550PFG) Junction-to-Ambient (R_{0,JA})

K Н -B-

-Y-

⊕ 0.25 (0.010) M B M Y



TO-220 FULLPAK, 2-LEAD CASE 221E-01 ISSUE A

-T- SEATING PLANE

- S

DATE 21 JAN 2008

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.617	0.633	15.67	16.07
В	0.392	0.408	9.96	10.36
С	0.177	0.193	4.50	4.90
D	0.024	0.039	0.60	1.00
F	0.121	0.129	3.08	3.28
G	0.100	BSC	2.54	BSC
Н	0.117	0.133	2.98	3.38
J	0.018	0.025	0.45	0.64
K	0.499	0.562	12.68	14.27
L	0.045	0.060	1.14	1.52
N	0.200	BSC	5.08	BSC
Q	0.122	0.138	3.10	3.50
R	0.101	0.117	2.56	2.96
S	0.092	0.108	2.34	2.74
U	0.255	0.271	6.48	6.88

STYLE 1: PIN 1. CATHODE

2. N/A 3. ANODE

GENERIC MARKING DIAGRAM*



= Assembly Location Α

= Year ww = Work Week G = Pb-Free Package = Device Code XXXXXX KΑ = Polarity Designator

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present.

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DESCRIPTION:	TO-220 FULLPAK, 2-LEAD		PAGE 1 OF 2



DOCUMENT NUMBER: 98ASB42851B

PAGE 2 OF 2

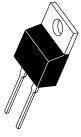
ISSUE	REVISION	DATE
A	ADDED 2-LEAD TO PACKAGE DESCRIPTION. UPDATED MIN & MAX VALUES	21 JAN 2008
A	FOR SEVERAL DIMENSIONS. ADDED MARKING DIAGRAM. REQ. BY M. SCHAGER.	21 JAN 2000
	+	
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	+	

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MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS





SCALE 1:1

TO-220, 2-LEAD CASE 221B-04 ISSUE F

DATE 12 APR 2013

NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.595	0.620	15.11	15.75
В	0.380	0.405	9.65	10.29
С	0.160	0.190	4.06	4.82
D	0.025	0.039	0.64	1.00
F	0.142	0.161	3.61	4.09
G	0.190	0.210	4.83	5.33
Н	0.110	0.130	2.79	3.30
J	0.014	0.025	0.36	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.14	1.52
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.14	1.39
T	0.235	0.255	5.97	6.48
U	0.000	0.050	0.000	1.27

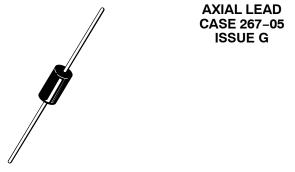
Q

STYLE 1: PIN 1. CATHODE 2. N/A 3. ANODE

PIN 1. ANODE 2. N/A 3. CATHODE 4. ANODE

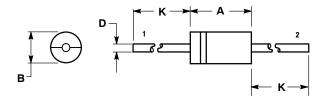
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DATE 06/06/2000

SCALE 1:1



- NOTES:

 1. DIMENSIONS AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: INCH.

 3. 267-04 OBSOLETE, NEW STANDARD 267-05.

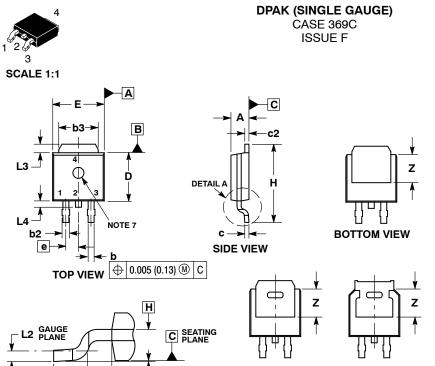
	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.287	0.374	7.30	9.50
В	0.189	0.209	4.80	5.30
D	0.047	0.051	1.20	1.30
K	1.000		25.40	

STYLE 2: NO POLARITY STYLE 1: PIN 1. CATHODE (POLARITY BAND) 2. ANODE

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DATE 21 JUL 2015



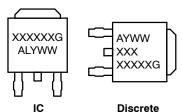
NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: INCHES.
- 3. THERMAL PAD CONTOUR OPTIONAL WITHIN DI-
- MENSIONS b3, L3 and Z.
 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.006 INCHES PER SIDE.
 5. DIMENSIONS D AND E ARE DETERMINED AT THE
- OUTERMOST EXTREMES OF THE PLASTIC BODY.

 6. DATUMS A AND B ARE DETERMINED AT DATUM
- 7. OPTIONAL MOLD FEATURE.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.086	0.094	2.18	2.38	
A1	0.000	0.005	0.00	0.13	
b	0.025	0.035	0.63	0.89	
b2	0.028	0.045	0.72	1.14	
b3	0.180	0.215	4.57	5.46	
С	0.018	0.024	0.46	0.61	
c2	0.018	0.024	0.46	0.61	
D	0.235	0.245	5.97	6.22	
E	0.250	0.265	6.35	6.73	
е	0.090	0.090 BSC		2.29 BSC	
Н	0.370	0.410	9.40	10.41	
L	0.055	0.070	1.40	1.78	
L1	0.114 REF		2.90 REF		
L2	0.020 BSC		0.51 BSC		
L3	0.035	0.050	0.89	1.27	
L4		0.040		1.01	
Z	0.155		3.93		

GENERIC MARKING DIAGRAM*



XXXXXX = Device Code

= Assembly Location Α

L = Wafer Lot Υ = Year WW = Work Week G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking.

SOLDERING FOOTPRINT*

STYLE 8:

STYLE 3:

PIN 1. N/C 2. CATHODE

3. ANODE 4. CATHODE

PIN 1. ANODE 2. CATHODE

3. ANODE

4. CATHODE

STYLE 9:

PIN 1. ANODE 2. CATHODE

Α1

STYLE 2:

PIN 1. GATE 2. COLLECTOR

3. EMITTER 4. COLLECTOR

PIN 1. GATE 2. DRAIN

SOURCE

4. DRAIN

DETAIL A ROTATED 90° CW

STYLE 7:

STYLE 1:

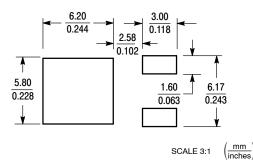
STYLE 6:

PIN 1. MT1 2. MT2

3. GATE 4. MT2

PIN 1. BASE 2. COLLECTOR 3. EMITTER

4. COLLECTOR



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	DPAK (SINGLE GAUGE)		PAGE 1 OF 1

BOTTOM VIEW

ALTERNATE CONSTRUCTIONS

STYLE 5:

STYLE 10:

PIN 1. GATE 2. ANODE 3. CATHODE

4. ANODE

PIN 1. CATHODE 2. ANODE

3. CATHODE 4. ANODE

STYLE 4:

PIN 1. CATHODE 2. ANODE 3. GATE

4. ANODE

3. RESISTOR ADJUST 4. CATHODE

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MUR550APF MUR550APFRL MUR550APFRLG MUR550PF MUR550PFG MURD550PFT4 MURD550PFT4G MURD550PFT4G NRVUD550PFT4G-VF01